## NSN 5962-00-137-5013

Memory Microcircuit - Page 1 of 1



View Online at https://aerobasegroup.com/nsn/5962-00-137-5013 **Body Length:** 0.390 inches **Body Width:** 0.390 inches **Body Height:** Between 0.030 inches and 0.070 inches **Maximum Power Dissipation Rating:** 580.0 milliwatts **Operating Tempurature Range:** -55.0/+125.0 degrees celsius Storage Tempurature Range: -65.0/+165.0 degrees celsius **Features Provided:** Hermetically sealed and monolithic and dynamic and edge triggered and positive outputs and programmable and w/buffered output and w/clear and w/decoded output and w/enable and w/strobe **Inclosure Material:** Glass and metal **Inclosure Configuration:** Flat pack **Output Logic Form:** P-type metal oxide-semiconductor logic **Input Circuit Pattern:** 19 input **Terminal Surface Treatment:** Solder **Voltage Rating And Type Per Characteristic:** -28.0 volts power source and 0.3 volts power source **Memory Device Type:** Rom **Test Data Document:** 09128-d34005713 drawing (this is the basic governing drawing, such as a contractor drawing, original equipment manufacturer drawing, etc.; excludes any specification, standard or other document that may be referenced in a basic governing drawing) **Terminal Type And Quantity:** 30 flat leads Shelf Life: N/a **Unit Of Measure:** 

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**Demilitarization:** Yes - demil/mli